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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

TI-36160

Dale E. Hocevar

Art Unit: 2133

Serial No.: 10/806,879

Examiner:

Filed: March 23, 2004

Conf. No: 3869

For: Layered Low Density Parity Check Decoding for Digital Communications

LETTER TO THE OFFICIAL DRAFTSPERSON

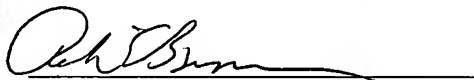
Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)
I hereby certify that the above correspondence is being deposited
with the U.S. Postal Service as First Class Mail in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450, on June 28, 2005.


Robin E. Barnum

In response to the correspondence dated June 6, 2005, please find enclosed the formal drawings for the subject case. However, Applicant would like to point out that the drawings filed with this Application on March 23, 2004 were INFORMAL DRAWINGS and were indicated as such in all the filing paperwork. The drawings submitted May 17, 2004 were the FORMAL DRAWINGS and were NOT "Replacement Sheets". However, to expedite this application, Applicant has resubmitted the Formal Drawings as "Replacement Sheets".

Respectfully submitted,



Abdul Zindani
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Reg. No. 46,091

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